

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
LIANG HUANG	11/29/2018
BRUCE ALLEN CHAMPION	11/30/2018
RECEIVING PARTY DATA	
Name:	TYCO ELECTRONICS (SHANGHAI) CO. LTD.
Street Address:	SECTIONS F & G, LEVEL 1, BUILDING 15, NO. 999 YINGLUN RD.
Internal Address:	CHINA (SHANGHAI) PILOT FREE TRADE ZONE
City:	SHANGHAI
State/Country:	CHINA
Name:	TE CONNECTIVITY CORPORATION
Street Address:	1050 WESTLAKES DRIVE
City:	BERWYN
State/Country:	PENNSYLVANIA
Postal Code:	19312
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16233310
CORRESPONDENCE DATA	
Fax Number:	(610)889-3696
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	610-889-3699
Email:	berwynipdocket@barley.com
Correspondent Name:	BARLEY SNYDER
Address Line 1:	2 GREAT VALLEY PARKWAY
Address Line 2:	SUITE 110
Address Line 4:	MALVERN, PENNSYLVANIA 19355
ATTORNEY DOCKET NUMBER:	21334-2735
NAME OF SUBMITTER:	SALVATORE ANASTASI
SIGNATURE:	/Salvatore Anastasi/

DATE SIGNED:	12/27/2018
Total Attachments: 2 source=DecAssn1#page1.tif source=DecAssn2#page1.tif	

COMBINED DECLARATION AND ASSIGNMENT

As a below-named inventor, I hereby declare that:

this declaration is directed to inventions and improvements disclosed in:

- the attached application, or
- United States application or PCT international application number _____
filed on _____, entitled Circuit Board and Card ("the APPLICATION")

The APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;

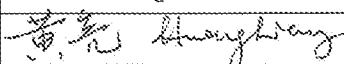
I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37.C.F.R 1.56; AND

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

Tyco Electronics (Shanghai) Co. Ltd. and TE Connectivity Corporation ("ASSIGNEE"), corporations organized and existing under and by virtue of the laws of China and United States, having their principal place of business at Sections F and G Level 1 Building 15 No. 999 Yinglun Road, China (Shanghai) Pilot Free Trade Zone, Shanghai, China and 1050 Westlakes Drive, Berwyn, Pennsylvania, 19312, United States,

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof, and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment

Legal Name	Signature	Date
HUANG, Liang		11.29.2018
CHAMPION, Bruce Allen		

Attorney Docket No.: 21334-2735

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I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;


I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37.C.F.R 1.56; AND

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Legal Name	Signature	Date
HUANG, Liang		
CHAMPION, Bruce Allen		30 Nov 18